PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HSIEN TENG-LIU	04/16/2020

RECEIVING PARTY DATA

Name:	PUMA SE	
Street Address:	s: PUMA WAY 1	
City:	HERZOGENAURACH	
State/Country:	ntry: GERMANY	
Postal Code:	91074	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16766662	

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ATTORNEY DOCKET NUMBER:	166755.00325	
NAME OF SUBMITTER:	NICHOLAS P. SCHMIDBAUER	
SIGNATURE: /NPSchmidbauer/		
DATE SIGNED:	06/29/2022	

Total Attachments: 1

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PATENT 507361367 REEL: 060355 FRAME: 0088

ASSIGNMENT

WHEREAS, the undersigned, <u>Hsien TENG-LIU</u>, has made an invention for which application for Letters Patent of the United States was filed in the United States Patent and Trademark Office as Application No. <u>16/766,662</u>, filed on <u>May 22, 2020</u>, naming the undersigned as inventor, and entitled <u>METHOD FOR THE PRODUCTION OF A SHOE</u>, <u>ESPECIALLY OF A SPORTS SHOE</u>; and

WHEREAS, <u>PUMA SE</u> (hereafter referred to as said Company), a German company having a place of business at <u>Puma Way 1, 91074 Herzogenaurach</u>, Germany is desirous of acquiring the entire interest in said inventions throughout the United States of America and the territories thereof, for all other countries and under all international agreements;

NOW, THEREFORE, for good and valuable consideration, receipt whereof is hereby acknowledged, the undersigned hereby sell(s), assign(s) and transfer(s) unto said Company, its successors and assigns, the entire right, title and interest throughout the United States of America and the territories thereof, for all foreign countries and under all international agreements in and to said inventions, the aforesaid application, all other applications hereafter filed in the United States, in any other country, or under any international agreement based in whole or in part on said inventions, and all Letters Patents granted upon said applications by the United States, by any other country or under any international agreement, and do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to said Company.

The undersigned further grants to said Company, its successors and assigns, the right to claim for any of said applications the full benefits and priority rights of any international agreement between the United States and any foreign country or countries of between any other countries. The undersigned hereby warrant(s) that they/(s)he have/has the full right to make the conveyance herein, and hereby covenant(s) that the heirs, legal representatives and assigns of the undersigned, will when requested, communicate to said Company, its representatives, successors and assigns, all facts known respecting said inventions, execute all divisional, continuing, reissue, reexamination and foreign or international applications, together with individual assignment therefore, make all rightful oaths, sign all lawful papers, testify in any legal proceeding and generally do everything possible to aid said Company, its successors and assigns, in the obtaining of Letters Patent.

The undersigned grants to the Company the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for the recordation of this document.

IN TESTIMONY WHEREOF, the undersigned has hereunto executed this assignment.

	Date	16 AM	بدود کا	Inventor Signature	HSIENTENG-LIN
				Inventor Name	Hsien TENG-LIÚ 美/ 名 月条
-				Mailing Address	Flr. 4, No. 10, Lane 289, Sec. 1,
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